



Product Change Notice

PCN #: PCNE19081901

Ver. 1.0

Issue Date: 2019/08/19

Type of Change: NAND Flash die change

Detailed Description of Change:

ATP hereby gives product change notification for NAND Flash die changes on SLC UFD NANODURA 512MB, 1GB, and 2GB.

Quality Impact: no minor major

Function Impact: no minor major

Reliability Impact: no minor major

Reason for Change:

Based on ATP product line planning and better longevity consideration, Micron SLC 25nm M70M based UFD NANODURA will be replaced by Micron SLC 25nm M71M based UFD NANODURA.

Products Affected & Replacements:

Current Part Number	New Part Number	Specification
AF512UFNDNC(I)-AABXX	AF512UFNDNC(I)-AAAXX	512MB
AF1GUFNDNC(I)-AABXX	AF1GUFNDNC(I)-AAAXX	1GB
AF2GUFNDNC(I)-AACXX	AF2GUFNDNC(I)-AAAXX	2GB

Method to Distinguish Change:

The laser engraved on UFD housing will be different to differentiate between the current (old) and new version.

Current	New	Specification
		512MB
		1GB
		2GB



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Implementation Date: 2019/08/19

Forecasted Milestones:

Milestone	Date
Qualification Samples	2019/08/19
Last Time Buy	2020/03/31
Last Time Shipment (with NCNR term)	2020/09/30

Recommended Action:

Please contact ATP representatives for LTB arrangement as well as new parts available for replacement or requalification.

Should you have any issues with the timeline or content of this change, please contact ATP representative **within 10 days**. No response will be deemed as customer's acceptance of the change and the change will be implemented pursuant to the milestones set forth in this PCN.